

DATA SHEET

SMV2026 Series: Surface-Mount, Silicon Hyperabrupt Tuning Varactor Diodes

Applications

- Wide-bandwidth and low phase-noise VCOs
- Wide-range, voltage-tuned phase shifters and filters
- Miniature RF and microwave tuners

Features

- Low series resistance and leakage current for low phase-noise VCOs
- High-capacitance ratio: $C_T(2\text{ V})/C_T(10\text{ V}) = 2.0$ minimum
- Broad 15-V tuning range
- Competitive cross to Toshiba 1SV179 varactor diode
- SC-79 and ultrasmall SOD-882 packages (MSL1, 260 °C per JEDEC J-STD-020)



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.



Description



The SMV2026 series are silicon surface-mount, hyperabrupt tuning varactor diodes, excellent for use as high-Q tuning elements in an RF Voltage Controlled Oscillator (VCO), voltage-controlled phase shifter, or tunable bandpass filter.

The minimum capacitance ratio from 2 V to 10 V is 2.0, which makes the SMV2026 series suitable for wide bandwidth VCOs and wide phase- range phase shifters.

The SMV2026 is manufactured in a surface-mount, industry-standard SC-79 package and an ultrasmall SOD-882 package that offer very low parasitic inductance and capacitance.

Table 1 describes the packages and markings of the SMV2026 series diodes.

Table 1. Packaging and Marking

	
Single	Single
SC-79 Green™	SOD-882 Green™
SMV2026-079LF Marking: Cathode	SMV2026-040LF Marking: EC1
Ls = 0.70 nH	Ls = 0.45 nH



The Pb-free symbol or "LF" in the part number denotes a lead-free, RoHS-compliant package unless otherwise noted as Green™. Tin/lead (Sn/Pb) packaging is not recommended for new designs.

Electrical and Mechanical Specifications

The absolute maximum ratings for the SMV2026 series are provided in Table 2. Electrical specifications are provided in Table 3. Table 4 summarizes the typical capacitance for reverse voltages between 0 and 20 V.

Typical performance characteristics are illustrated in Figures 1 and 2. The SPICE model for the SMV2026 series of varactor diodes is shown in Figure 3 and the associated model parameters are provided in Table 5.

Package Dimensions

Package dimensions for the SMV2026 series are provided in Figure 4 (SC-79) and Figure 6 (SOD-882). Tape and reel dimensions are provided in Figure 5 (SC-79) and

Figure 7 (SOD-882). For the PCB layout footprint, refer to the Skyworks Application Note, *Suggested PCB Land Pattern Designs for Leaded and Leadless Packages, and Detailed Surface Mount Guidelines for Leadless Packages*, document number 200123.

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

Table 2. SMV2026 Series Absolute Maximum Ratings (Note 1)

Parameter	Symbol	Minimum	Maximum	Units
Forward current	I_F		100	mA
Reverse voltage	V_R		15	V
Dissipated power @ 25 °C	P_D		250	mW
Storage temperature	T_{STG}	-55	+200	°C
Junction temperature	T_J	-55	+175	°C
Solder interface temperature	T_S	-40	+85	°C
Electrostatic Discharge: Charged-Device Model (CDM), Class 4 Human Body Model (HBM), Class 3A Machine Model (MM), Class C	ESD		2000 4000 400	V V V

Note 1: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

CAUTION: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

Table 3. SMV2026 Series Electrical Specifications (Note 1)
($T_S = +25\text{ °C}$, Characteristic Impedance [Z_0] = 50 Ω , Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Reverse current	I_R	$V_R = 15\text{ V}$			20	nA
Capacitance	C_T	$f = 1\text{ MHz}$ $V_R = 2\text{ V}$ $V_R = 10\text{ V}$	14.0 5.5		16.0 6.5	pF pF
Capacitance ratio	C_{TR}	$C_T @ 2\text{ V}/C_T @ 10\text{ V}$	2.0	2.5		-
Series resistance	R_S	$f = 470\text{ MHz}, V_R = 5\text{ V}$		0.5		Ω
Breakdown voltage	V_{BR}	$I_R = 10\text{ }\mu\text{A}$	15			V

Note 1: Performance is guaranteed only under the conditions listed in this Table.

The SMV2026 series are rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. They can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

Table 4. Reverse Voltage vs Typical Capacitance

V _R (V)	C _T (pF)	V _R (V)	C _T (pF)
0	27.09	8	6.92
1	18.01	9	6.29
2	14.27	10	5.69
3	12.06	12	4.58
4	10.52	14	3.74
5	9.35	16	3.28
6	8.41	18	3.10
7	7.62	20	3.01

Typical Performance Characteristics

(T_A = 25 °C, Unless Otherwise Noted)

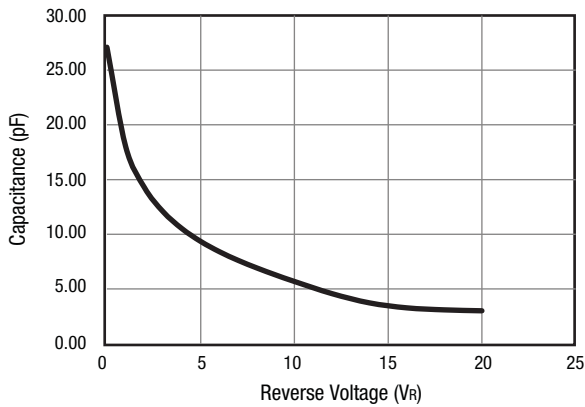


Figure 1. Capacitance vs Reverse Voltage

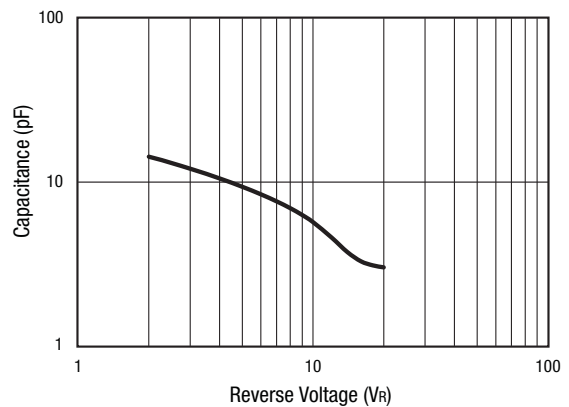


Figure 2. Capacitance vs Reverse Voltage

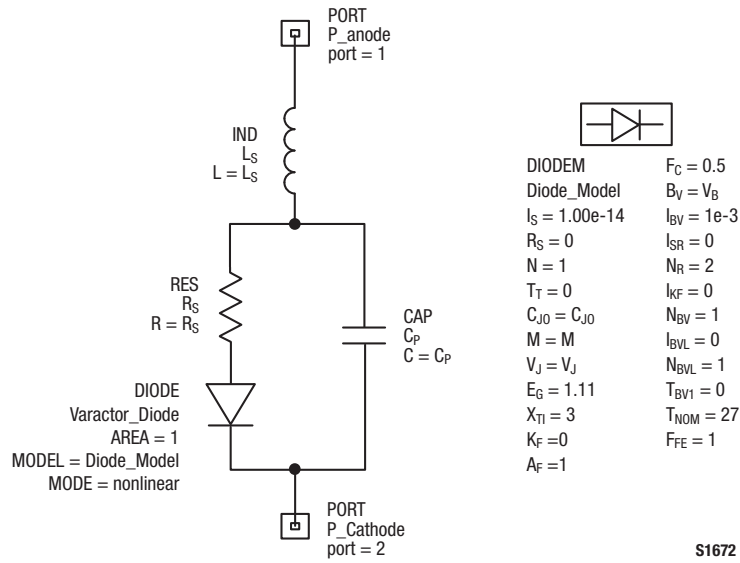
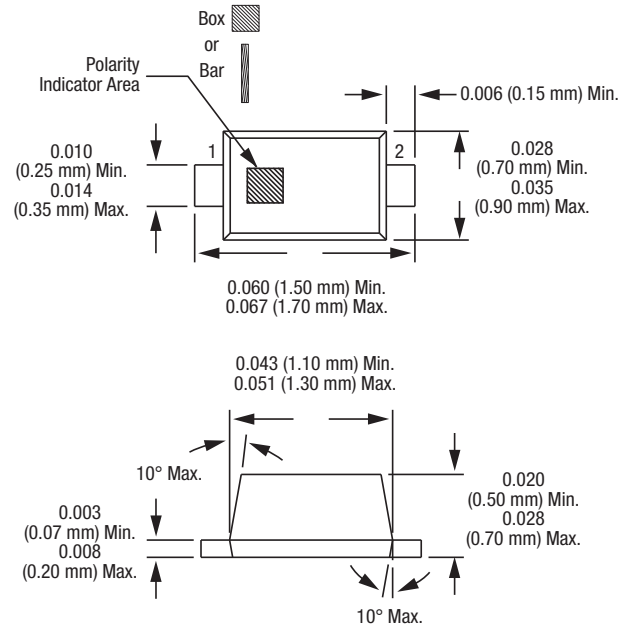


Figure 3. SPICE Model

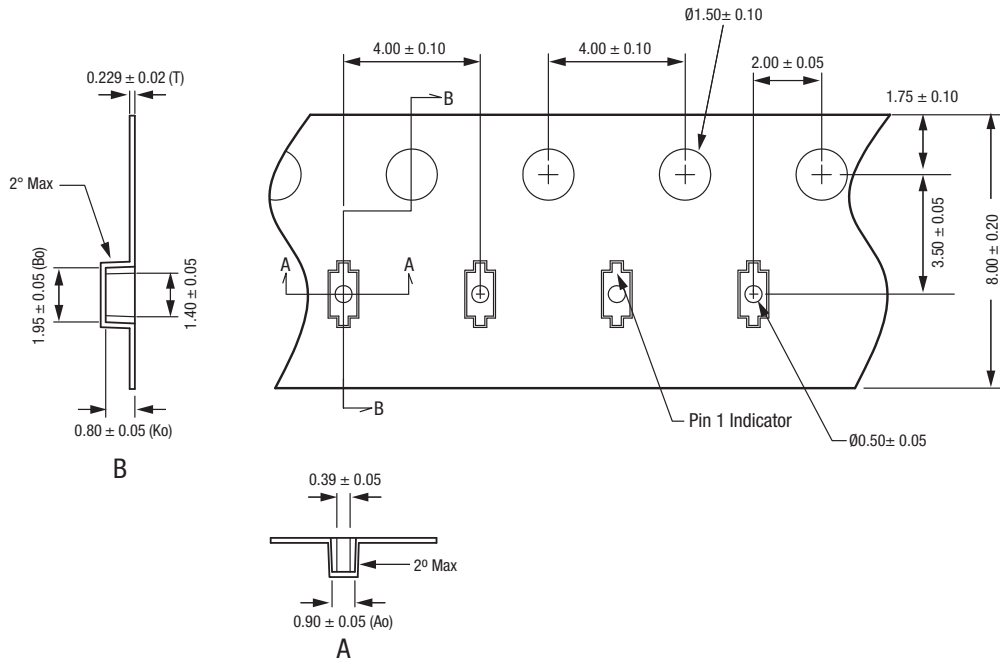
Table 5. SPICE Model Parameters

Part Number	CJO (pF)	VJ (V)	M	Cp (pF)	Rs (Ω)	Ls (nH)
SMV2026-079LF	8.8	1.05	0.65	0.07	0.8	0.70
SMV2026-040LF	8.8	1.05	0.65	0.07	0.8	0.45



Dimensions are in inches (millimeters shown in parentheses) S1652

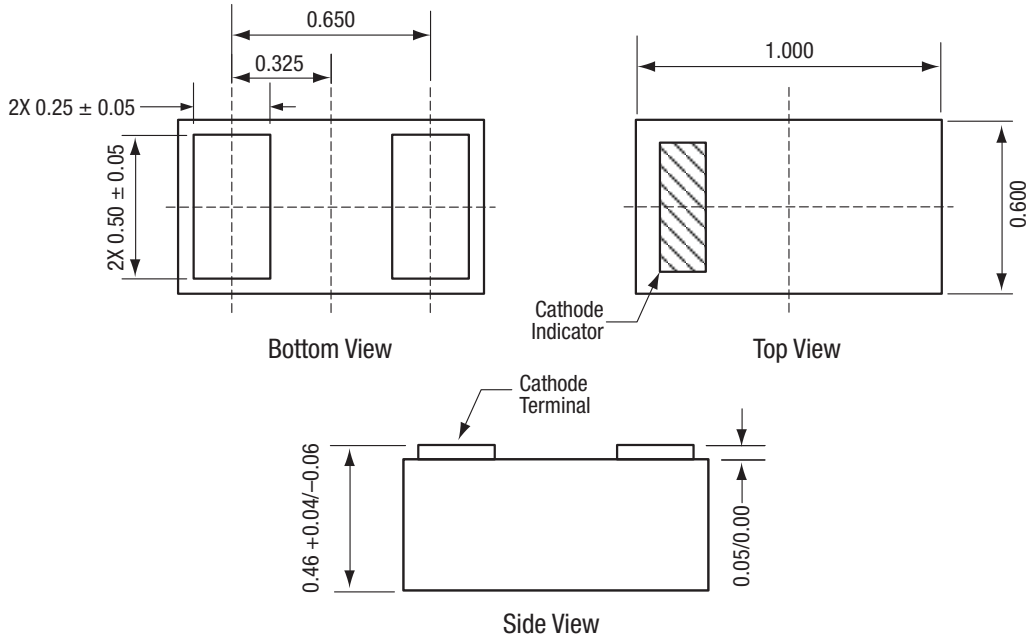
Figure 4. SMV2026-079LF Package Dimensions (SC-79)



- Notes:
1. Carrier tape: black conductive polycarbonate or polystyrene.
 2. Cover tape material: transparent conductive PSA.
 3. Cover tape size: 5.4 mm width.
 4. ESD-surface resistivity is $\leq 1 \times 10^8$ Ohms/square per EIA, JEDEC TNR Specification.
 4. All measurements are in millimeters.

S2929

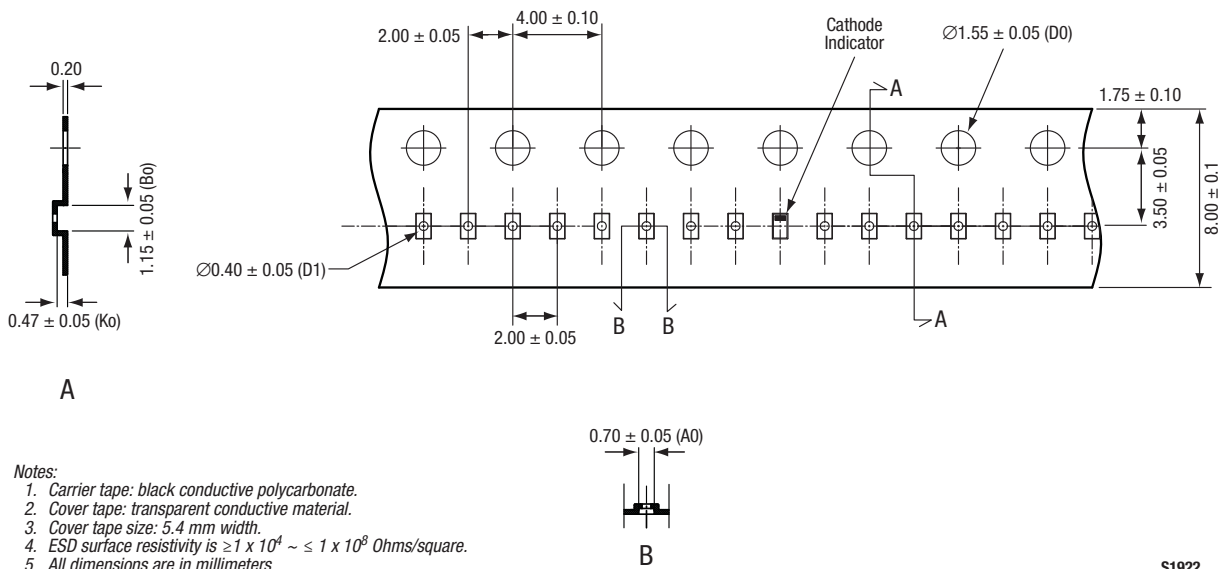
Figure 5. SMV2026-079LF Tape and Reel Dimensions (SC-79)



All dimensions in millimeters

S1892

Figure 6. SMV2026-040LF Package Dimensions (SOD-882)



S1922

Figure 7. SMV2026-040LF Tape and Reel Dimensions (SOD-882)